

N-channel silicon field-effect transistors

Rev. 4 — 20 September 2011

Product data sheet

1. Product profile

1.1 General description

Symmetrical N-channel silicon junction field-effect transistors in a SOT23 package.

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

1.2 Features and benefits

- Low noise
- Interchangeability of drain and source connections
- High gain.

1.3 Applications

- AM input stage in car radios
- VHF amplifiers
- Oscillators and mixers.

1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{DS}	drain-source voltage		-	-	±25	V
V _{GSoff}	gate-source cut-off voltage					
	PMBFJ308	V_{DS} = 10 V; I_D = 1 μ A	-1	-	-6.5	V
	PMBFJ309	V_{DS} = 10 V; I_D = 1 μ A	-1	-	-4	V
	PMBFJ310	V_{DS} = 10 V; I_D = 1 μ A	-2	-	-6.5	V



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Table 1.	Quick reference data continued							
Symbol	Parameter	Conditions	Min	Тур	Max	Unit		
I _{DSS}	drain current							
	PMBFJ308	$V_{GS} = 0 V; V_{DS} = 10 V$	12	-	60	mA		
	PMBFJ309	$V_{GS} = 0 V; V_{DS} = 10 V$	12	-	30	mA		
	PMBFJ310	$V_{GS} = 0 V; V_{DS} = 10 V$	24	-	60	mA		
P _{tot}	total power dissipation	up to T _{amb} = 25 °C	-	-	250	mW		
y _{fs}	forward transfer admittance	V_{DS} = 10 V; I_{D} = 10 mA	10	-	-	mS		

2. Pinning information

Table 2.	Discrete pinning ^[1]		
Pin	Description	Simplified outline	Symbol
1	source		
2	drain		$3 \rightarrow 1$
3	gate		sym060

[1] Drain and source are interchangeable.

3. Ordering information

Table 3. Ordering information						
Type number	Package	ackage				
	Name	Description	Version			
PMBFJ308	-	plastic surface mounted package; 3 leads	SOT23			
PMBFJ309						
PMBFJ310						

4. Marking

Table 4. Marking	
Type number	Marking code ^[1]
PMBFJ308	48*
PMBFJ309	49*
PMBFJ310	50*

[1] * = p: Made in Hong Kong.

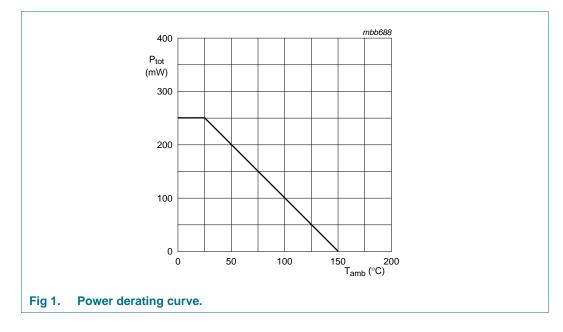
* = t: Made in Malaysia.

* = W: Made in China.

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5. Limiting values

Table 5. In accorda	Limiting values nce with the Absolute Maximum F	Rating System (IEC 60134).			
Symbol	Parameter	Conditions	Min	Мах	Unit
V _{DS}	drain-source voltage (DC)		-	±25	V
V _{GSO}	gate-source voltage	open drain	-	-25	V
V_{GDO}	gate-drain voltage	open source	-	-25	V
l _G	forward gate current (DC)		-	50	mA
P _{tot}	total power dissipation	up to $T_{amb} = 25 \ ^{\circ}C$	-	250	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C



6. Thermal characteristics

Table 6.	Thermal characteristics			
Symbol	Parameter	Conditions	Тур	Unit
R _{th(j-a)}	thermal resistance from junction to ambient		<u>[1]</u> 500	K/W

[1] Device mounted on an FR4 printed-circuit board.

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7. Static characteristics

Table 7.Static characteristics

 $T_i = 25 \ ^{\circ}C$; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{(BR)GSS}	gate-source breakdown voltage	$I_{G} = -1 \ \mu A; \ V_{DS} = 0 \ V$	-25	-	-	V
V _{GSoff}	gate-source cut-off voltage					V
	PMBFJ308	$I_D = 1 \ \mu A; \ V_{DS} = 10 \ V$	-1	-	-6.5	V
	PMBFJ309	$I_D = 1 \ \mu A; \ V_{DS} = 10 \ V$	-1	-	-4	V
	PMBFJ310	$I_D = 1 \ \mu A; \ V_{DS} = 10 \ V$	-2	-	-6.5	V
V _{GSS}	gate-source forward voltage	$I_{G} = 1 \text{ mA}; V_{DS} = 0 \text{ V}$	-	-	1	V
I _{DSS}	drain-source leakage current					
	PMBFJ308	$V_{GS} = 0 V; V_{DS} = 10 V$	12	-	60	mA
	PMBFJ309	$V_{GS} = 0 V; V_{DS} = 10 V$	12	-	30	mA
	PMBFJ310	$V_{GS} = 0 V; V_{DS} = 10 V$	24	-	60	mA
I _{GSS}	gate-source leakage current	V_{GS} = -15 V; V_{DS} = 0 V	-	-	-1	nA
R _{DSon}	drain-source on-state resistance	$V_{GS} = 0 V; V_{DS} = 100 mV$	-	50	-	Ω
y _{fs}	forward transfer admittance	$I_D = 10 \text{ mA}; V_{DS} = 10 \text{ V}$	10	-	-	mS
y _{os}	common source output admittance	I _D = 10 mA; V _{DS} = 10 V	-	-	250	μS

8. Dynamic characteristics

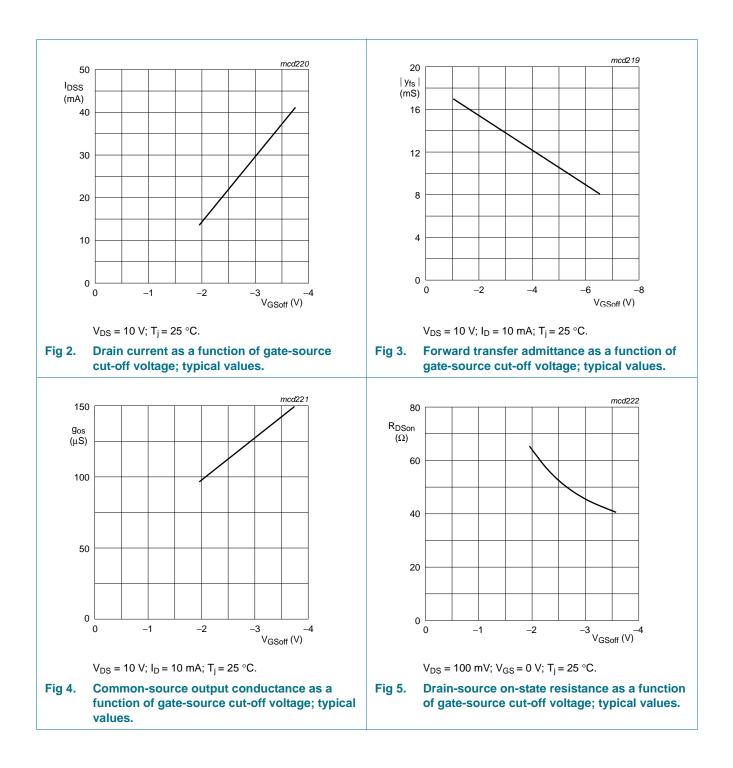
Table 8.Dynamic characteristics

$T_i = 25 \ ^{\circ}C;$ unless	otherwise s	pecified.
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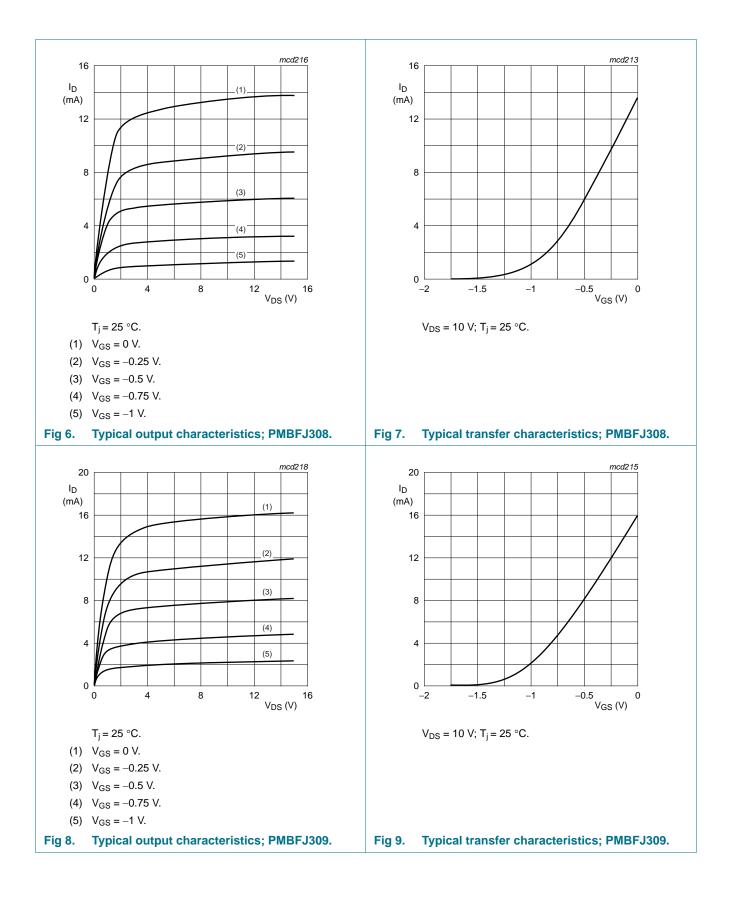
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
C _{iss}	input capacitance	V _{DS} = 10 V				
		$V_{GS} = -10 \text{ V}; \text{ f} = 1 \text{ MHz}$	-	3	5	pF
		V_{GS} = 0 V; T_{amb} = 25 °C	-	6	-	pF
C _{rss}	reverse transfer capacitance	V_{DS} = 0 V; V_{GS} = -10 V; f = 1 MHz	-	1.3	2.5	pF
g _{is} input conductance		V _{DS} = 10 V; I _D = 10 mA				
	f = 100 MHz	-	200	-	μS	
	f = 450 MHz	-	3	-	mS	
g _{fs}	transfer conductance	V _{DS} = 10 V; I _D = 10 mA				
		f = 100 MHz	-	13	-	mS
		f = 450 MHz	-	12	-	mS
9rs	reverse conductance	V _{DS} = 10 V; I _D = 10 mA				
		f = 100 MHz	-	-30	-	μS
		f = 450 MHz	-	-450	-	μS
g _{os}	output conductance	V _{DS} = 10 V; I _D = 10 mA				
		f = 100 MHz	-	150	-	μS
		f = 450 MHz	-	400	-	μS
/ _n	equivalent input noise voltage	V _{DS} = 10 V; I _D = 10 mA; f = 100 Hz	-	6	-	nV/√H

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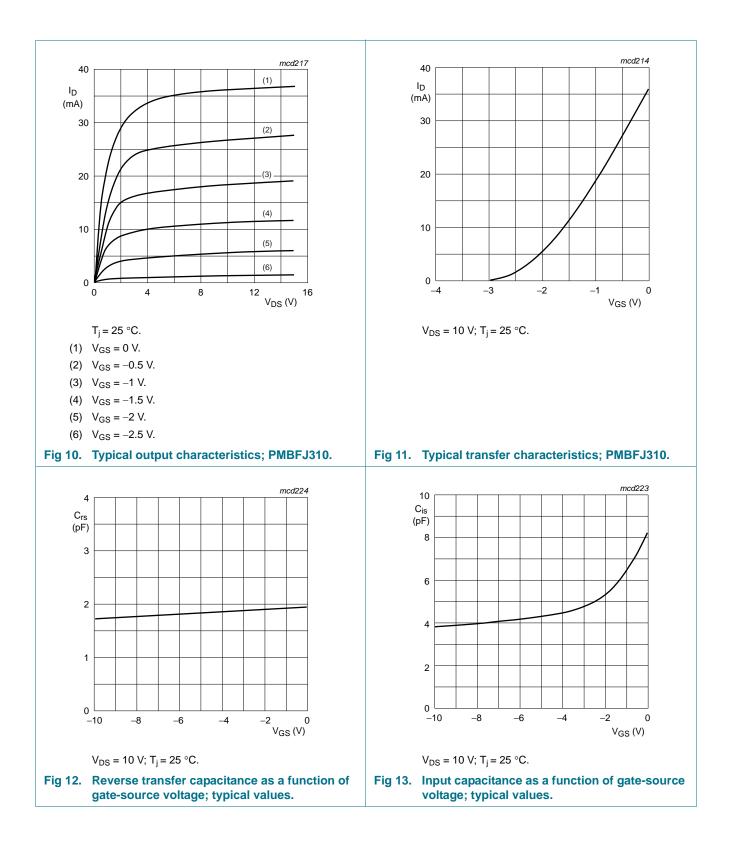
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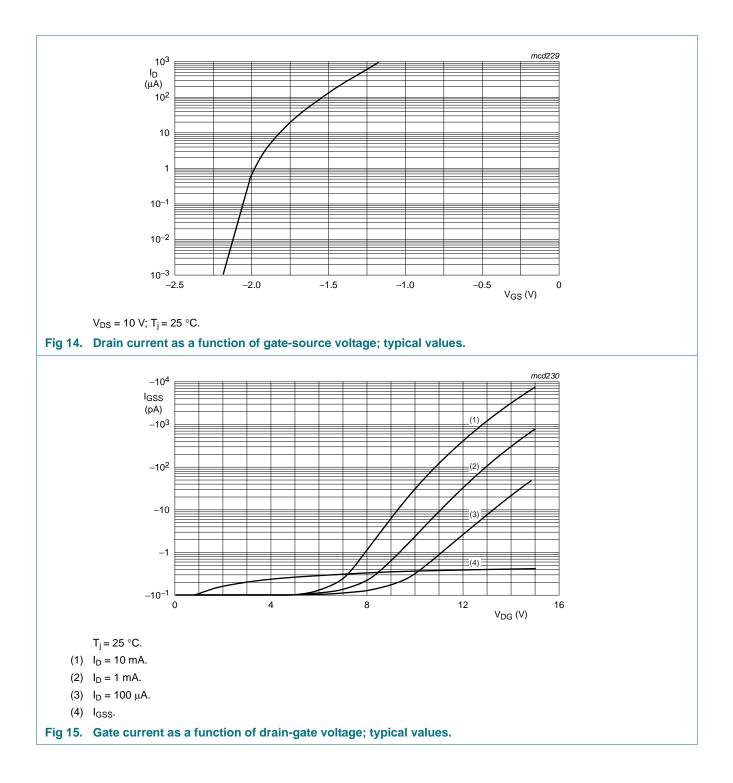


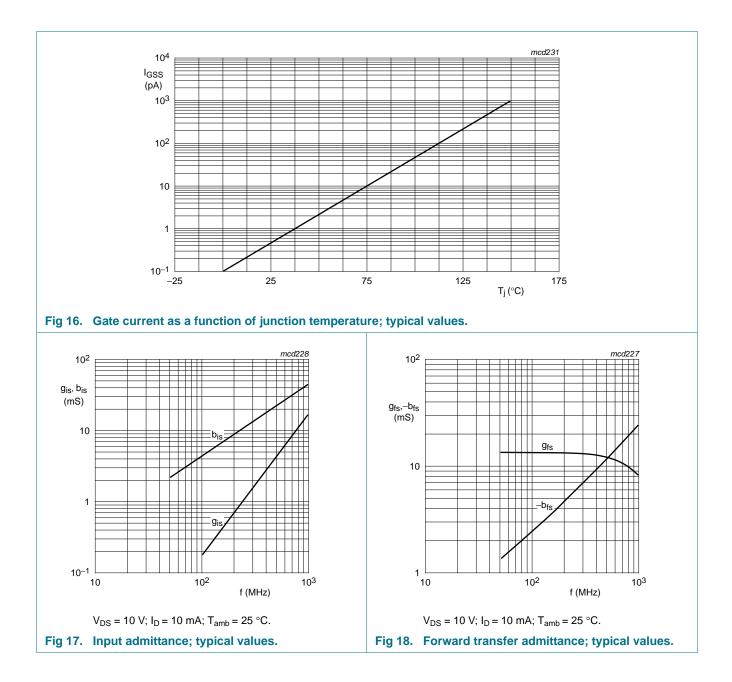
PMBFJ308; PMBFJ309; PMBFJ310



PMBFJ308; PMBFJ309; PMBFJ310

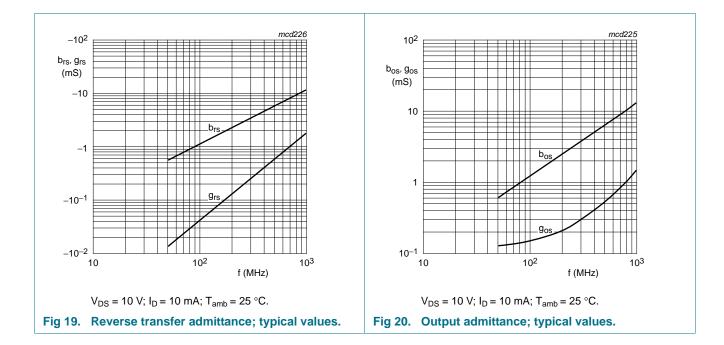






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9. Package outline

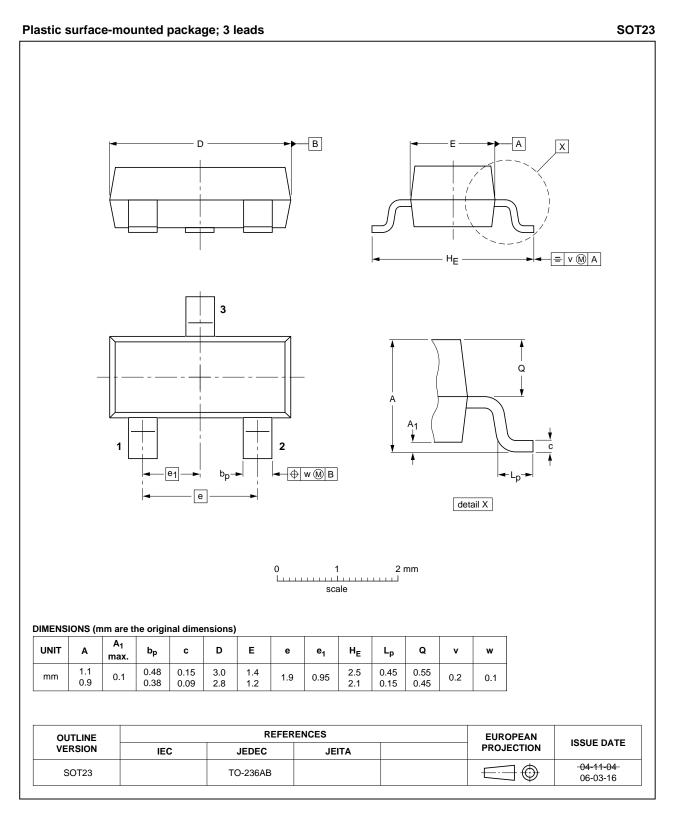


Fig 21. Package outline.

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PMBFJ308_309_310

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10. Revision history

Table 9.	Revision history				
Documen	it ID	Release date	Data sheet status	Change notice	Supersedes
PMBFJ30	8_309_310 v.4	20110920	Product data sheet	-	PMBFJ308_309_310 v.3
Modification	ons:		of this data sheet has be of NXP Semiconductors.	een redesigned to	comply with the new identity
		 Legal texts 	have been adapted to th	e new company n	ame where appropriate.
		 Package ou 	utline drawings have bee	n updated to the la	atest version.
PMBFJ30 (9397 750	8_309_310 v.3 13403)	20040723	Product data sheet	-	PMBFJ308_309_310 v.2
	8_309_310 v.2 01141)	19960911	Product specification	-	-

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11. Legal information

11.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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